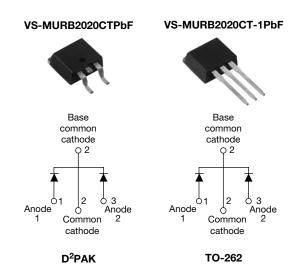


Vishay High Power Products

#### Ultrafast Rectifier, 2 x 10 A FRED Pt<sup>®</sup>



PRODUCT SUMMARY	
t <sub>rr</sub>	25 ns
I <sub>F(AV)</sub>	2 x 10 A
V <sub>R</sub>	200 V

#### FEATURES

- Ultrafast recovery time
- Low forward voltage drop
- Low leakage current
- 175 °C operating junction temperature
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Halogen-free according to IEC 61249-2-21 definition
- Compliant to RoHS directive 2002/95/EC
- AEC-Q101 qualified

#### **DESCRIPTION/APPLICATIONS**

MUR.. series are the state of the art ultrafast recovery rectifiers specifically designed with optimized performance of forward voltage drop and ultrafast recovery time.

The planar structure and the platinum doped life time control, guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in the output rectification stage of SMPS, UPS, dc-to-dc converters as well as freewheeling diode in low voltage inverters and chopper motor drives.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RA	TINGS				
PARAMETER		SYMBOL	TEST CONDITIONS	MAX.	UNITS
Peak repetitive reverse voltage		V <sub>RRM</sub>		200	V
Average rectified forward current	per leg	1		10	
Average rectilied forward current	total device	IF(AV)	Rated $V_R$ , $T_C = 145 \ ^\circ C$	20	٨
Non-repetitive peak surge current pe	er leg	I <sub>FSM</sub>		100	A
Peak repetitive forward current per le	eg	I <sub>FM</sub>	Rated V <sub>R</sub> , square wave, 20 kHz, T <sub>C</sub> = 145 $^{\circ}$ C	20	
Operating junction and storage temp	eratures	T <sub>J</sub> , T <sub>Stg</sub>		- 65 to 175	°C

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_J = 25$ °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Breakdown voltage, blocking voltage	V <sub>BR</sub> , V <sub>R</sub>	I <sub>R</sub> = 100 μA	200	-	-		
		I <sub>F</sub> = 8 A, T <sub>J</sub> = 125 °C	-	-	0.85	V	
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 16 A	-	-	1.15		
		I <sub>F</sub> = 16 A, T <sub>J</sub> = 125 °C	-	-	1.05		
Povoroo lookogo ourront	1-	$V_R = V_R$ rated	-	-	15		
Reverse leakage current	I <sub>R</sub>	$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	-	250	μA	
Junction capacitance	CT	V <sub>R</sub> = 200 V	-	55	-	pF	
Series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from package body	-	8.0	-	nH	



FREE

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Ultrafast Rectifier, 2 x 10 A FRED Pt<sup>®</sup>

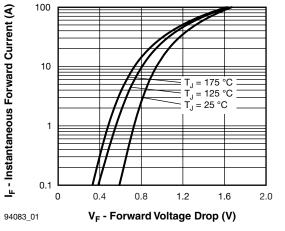


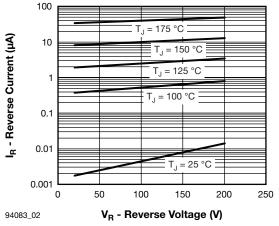
DYNAMIC RECOVERY	CHARAC	TERISTICS ( $T_J$ :	= 25 °C unless oth	nerwise sp	ecified)		
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS
		$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t =$	50 A/µs, V <sub>R</sub> = 30 V	-	-	35	
Povorso rocovoru timo	+	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1.0 A, I <sub>REC</sub> = 0.25 A		-	-	25	
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C	I <sub>F</sub> = 10 A dI <sub>F</sub> /dt = 200 A/μs V <sub>R</sub> = 160 V	-	21	-	ns
		T <sub>J</sub> = 125 °C		-	35	-	
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C		-	1.9	-	А
reak recovery current		T <sub>J</sub> = 125 °C		-	4.8	-	
Reverse recovery charge	0	T <sub>J</sub> = 25 °C		-	25	-	nC
neverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	78	-	ПС

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		- 65	-	175	°C
Thermal resistance, junction to case per leg	R <sub>thJC</sub>		-	-	2.5	
Thermal resistance, junction to ambient per leg	R <sub>thJA</sub>		-	-	50	°C/W
Thermal resistance, case to heatsink	R <sub>thCS</sub>	Mounting surface, flat, smooth and greased	-	0.5	-	
) ( / - : - <b>i</b> + +			-	2.0	-	g
Weight			-	0.07	-	oz.
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)
Marking daylige		Case style D <sup>2</sup> PAK		MURB	2020CT	
Marking device		Case style TO-262		MURB2	020CT-1	

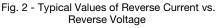


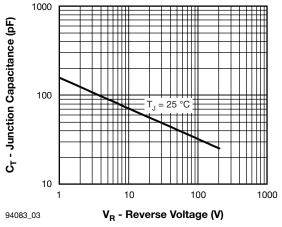
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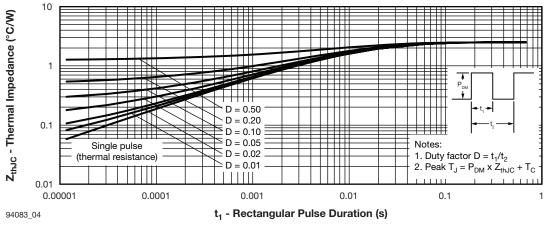


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics

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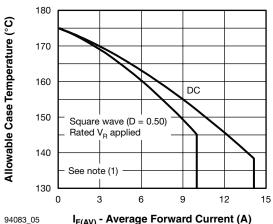
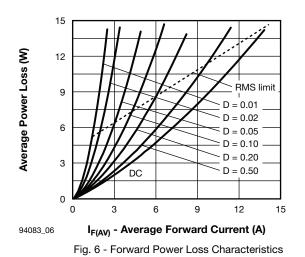




Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current



Note

<sup>(1)</sup> Formula used:  $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$ ;  $\begin{array}{l} \mathsf{Pd} = \mathsf{Forward} \ \mathsf{power} \ \mathsf{loss} = \mathsf{I}_{\mathsf{F}(\mathsf{AV})} \times \mathsf{V}_{\mathsf{FM}} \ \mathsf{at} \ (\mathsf{I}_{\mathsf{F}(\mathsf{AV})}/\mathsf{D}) \ (\mathsf{see} \ \mathsf{fig.} \ \mathsf{6}); \\ \mathsf{Pd}_{\mathsf{REV}} = \mathsf{Inverse} \ \mathsf{power} \ \mathsf{loss} = \mathsf{V}_{\mathsf{R1}} \times \mathsf{I}_{\mathsf{R}} \ (\mathsf{1} - \mathsf{D}); \ \mathsf{I}_{\mathsf{R}} \ \mathsf{at} \ \mathsf{V}_{\mathsf{R1}} = \mathsf{Rated} \ \mathsf{V}_{\mathsf{R}} \\ \end{array}$ 

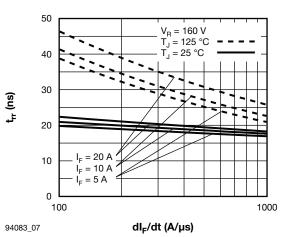
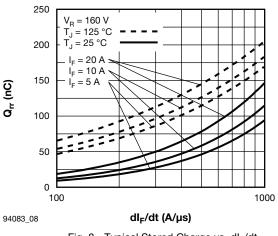


Fig. 7 - Typical Reverse Recovery Time vs. dI<sub>F</sub>/dt







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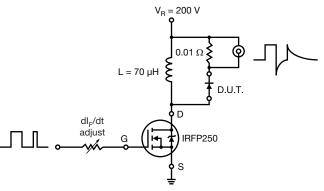


Fig. 9 - Reverse Recovery Parameter Test Circuit

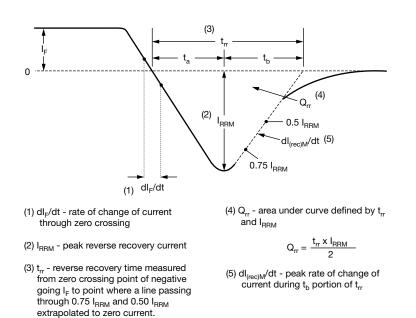


Fig. 10 - Reverse Recovery Waveform and Definitions



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#### **ORDERING INFORMATION TABLE**

Device code	vs-	MUR	В	20	20	СТ	-1	TRL	PbF
		(2)	(3)	4	(5)	(6)	(7)	(8)	(9)
	<b>1</b>	- HPF	P produ	ct suffix	_				
	2		•	JR serie	es				
	3	- B=	D <sup>2</sup> PAK	/TO-262					
	4								
	5	- Volt	age rati	ng (20 =	= 200 V)				
	6	- CT :	= Cente	er tap (du	ual) TO-	220/D <sup>2</sup> I	PAK/TC	0-262	
	7.	• • -1	= TO-2	62					
		• No	one = D	<sup>2</sup> PAK					
	8	• No	one = Ti	ube (50	pieces)				
		• TF	RL = Ta	pe and r	eel (left	oriente	d, for D	<sup>2</sup> PAK p	ackage)
		• TF	RR = Ta	pe and	reel (rig	ht orien	ted, for	D <sup>2</sup> PAK	packag
	9.	• • Pb	F = Lea	ad (Pb)-i	free				
		• P	= Lead	(Pb)-fre	e (for D <sup>2</sup>	<sup>2</sup> PAK T	RR and	TRL)	

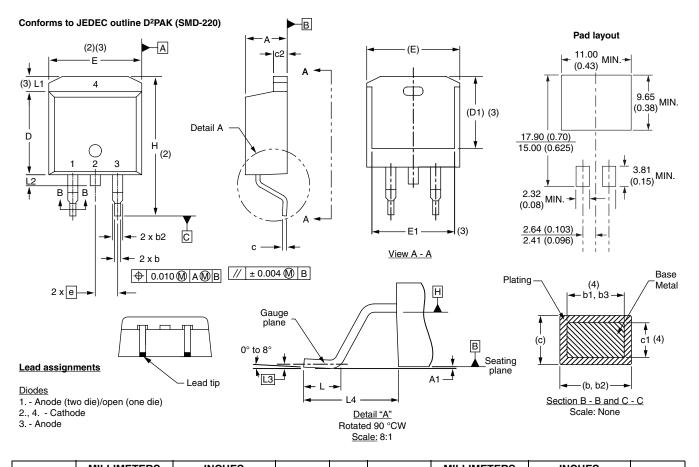
LINKS TO RELAT	ED DOCUMENTS
Dimensions	www.vishay.com/doc?95014
Part marking information	www.vishay.com/doc?95008
Packaging information	www.vishay.com/doc?95032

Vishay High Power Products

### D<sup>2</sup>PAK, TO-262

#### DIMENSIONS FOR D<sup>2</sup>PAK in millimeters and inches

SHA



SYMBOL	MILLIM	ETERS	INC	HES	NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
A	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MILLIM	ETERS	INC	HES	NOTES
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54	BSC	0.100	BSC	
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L2	1.27	1.78	0.050	0.070	
L3	0.25	BSC	0.010	BSC	
L4	4.78	5.28	0.188	0.208	

<sup>(7)</sup> Outline conforms to JEDEC outline TO-263AB

#### Notes

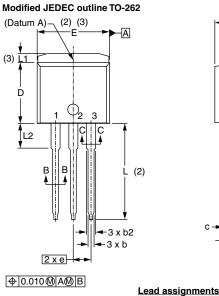
- <sup>(1)</sup> Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- $^{(3)}\,$  Thermal pad contour optional within dimension E, L1, D1 and E1
- <sup>(4)</sup> Dimension b1 and c1 apply to base metal only
- <sup>(5)</sup> Datum A and B to be determined at datum plane H
- <sup>(6)</sup> Controlling dimension: inch

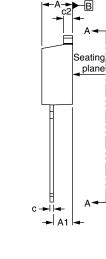
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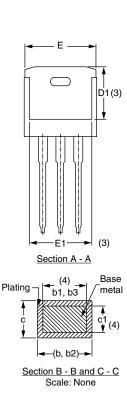
D<sup>2</sup>PAK, TO-262



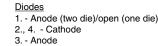
#### DIMENSIONS FOR TO-262 in millimeters and inches







Lead tip



OVMDOL	MILLIM	MILLIMETERS		IES	NOTEO
SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.06	4.83	0.160	0.190	
A1	2.03	3.02	0.080	0.119	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54 BSC		0.100	BSC	
L	13.46	14.10	0.530	0.555	
L1	-	1.65	-	0.065	3
L2	3.56	3.71	0.140	0.146	

#### Notes

- <sup>(1)</sup> Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- <sup>(3)</sup> Thermal pad contour optional within dimension E, L1, D1 and E1

<sup>(4)</sup> Dimension b1 and c1 apply to base metal only

<sup>(5)</sup> Controlling dimension: inches

<sup>(6)</sup> Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum) and D1 (minimum) where dimensions derived the actual package outline

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